

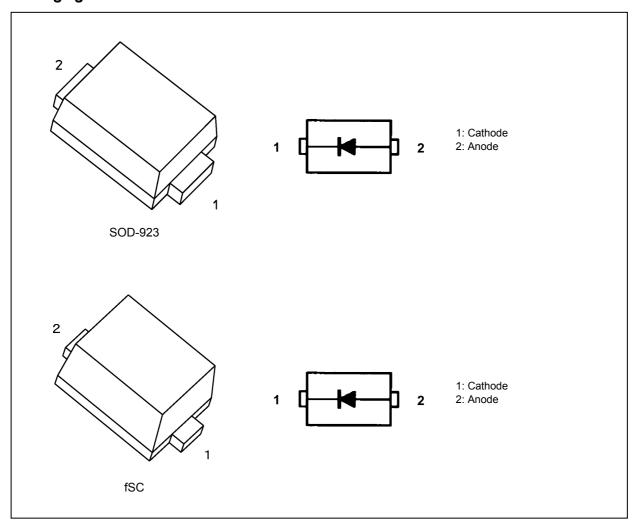
Switching Diodes Silicon Epitaxial Planar

1SS427

1. Applications

• Ultra-High-Speed Switching

2. Packaging and Internal Circuit





3. Absolute Maximum Ratings (Note) (Unless otherwise specified, $T_a = 25$ °C)

Characteristics	Symbol	Note	Rating	Unit
Peak reverse voltage	V _{RM}		85	V
Reverse voltage	V _R		80	
Peak forward current	I _{FM}		200	mA
Average rectified current	Io		100	
Power dissipation	P _D	(Note 1)	150	mW
Non-repetitive peak forward surge current	I _{FSM}	(Note 2)	1	Α
Junction temperature	Tj		150	°C
Storage temperature	T _{stg}		-55 to 150	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Mounted on a glass epoxy circuit board of 20 mm × 20 mm, Pad dimension of 4 mm × 4 mm.

Note 2: Measured with a 10 ms pulse.

4. Electrical Characteristics (Unless otherwise specified, T_a = 25 °C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Forward voltage	V _{F(1)}	I _F = 1 mA	-	0.62		V
	V _{F(2)}	I _F = 10 mA		0.75		
	V _{F(3)}	I _F = 100 mA		0.98	1.20	
Reverse current	I _{R(1)}	V _R = 30 V			0.1	μΑ
	I _{R(2)}	V _R = 80 V			0.5	
Total capacitance	Ct	V _R = 0 V, f = 1 MHz	_	0.3		pF
Reverse recovery time	t _{rr}	$I_F = 10 \text{ mA}$ See Fig. 5.1.	_	1.6		ns

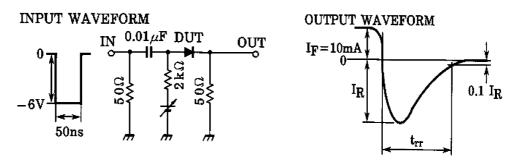
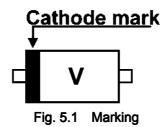


Fig. 4.1 Reverse recovery time (t_{rr}) Test circuit



5. Marking



6. Land Pattern Dimensions (for reference only)

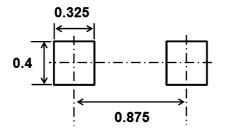


Fig. 6.1 SOD-923 (Unit: mm)

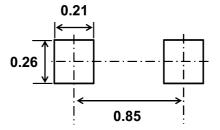
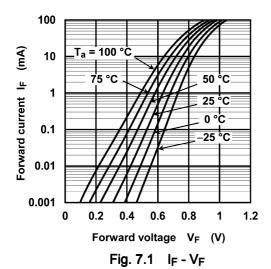


Fig. 6.2 fSC (Unit: mm)

7. Characteristics Curves (Note)



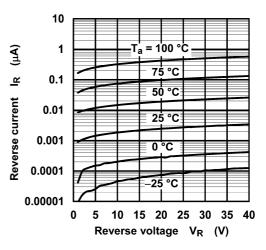
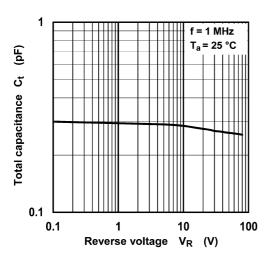


Fig. 7.2 I_R - V_R



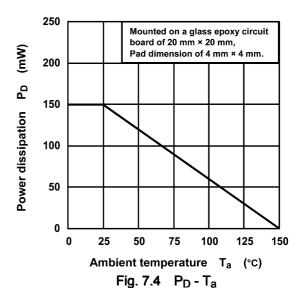


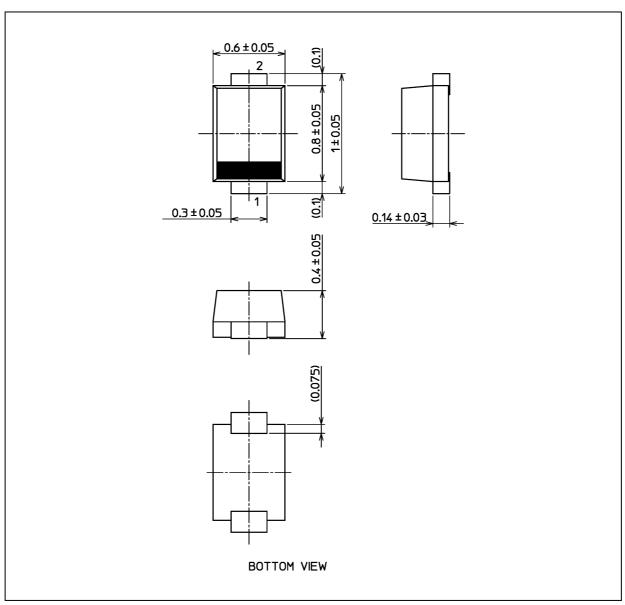
Fig. 7.3 Ct - VR

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



Package Dimensions

Unit: mm



The shapes and dimensions of the package vary, depending on the manufacturing plant. For details, contact the Toshiba sales representative.

Weight: 0.55 mg (typ.)

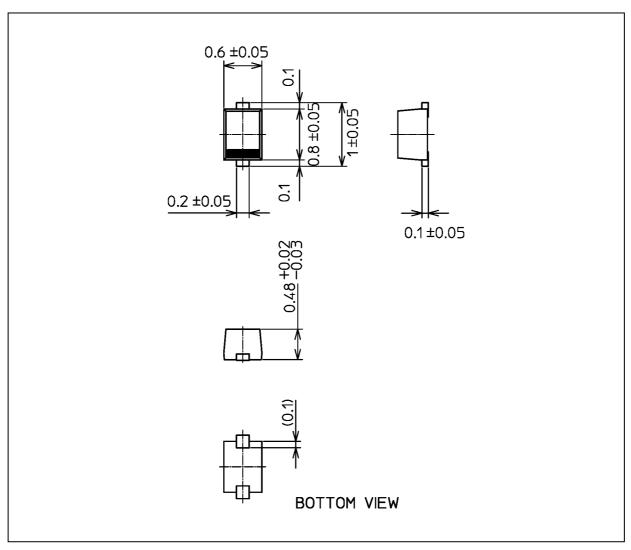
Package Name(s)
TOSHIBA: 1-1AH1A
Nickname: SOD-923

Rev.3.0



Package Dimensions

Unit: mm



The shapes and dimensions of the package vary, depending on the manufacturing plant. For details, contact the Toshiba sales representative.

Weight: 0.6 mg (typ.)

Package Name(s)
TOSHIBA: 1-1L1S
Nickname: fSC

Rev.3.0



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Тел: +7 (812) 336 43 04 (многоканальный) Email: org@lifeelectronics.ru